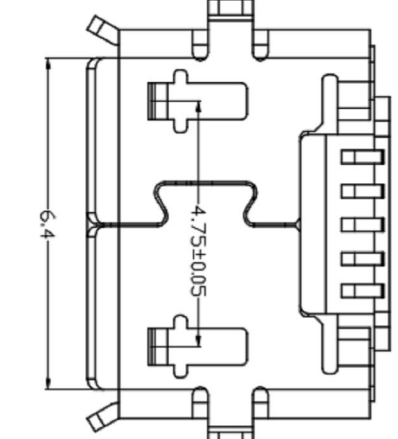
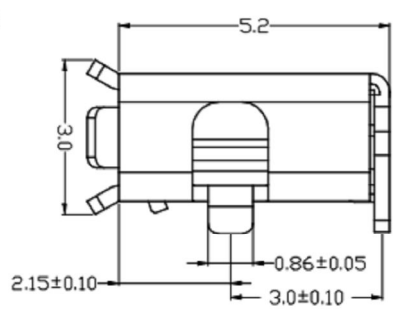
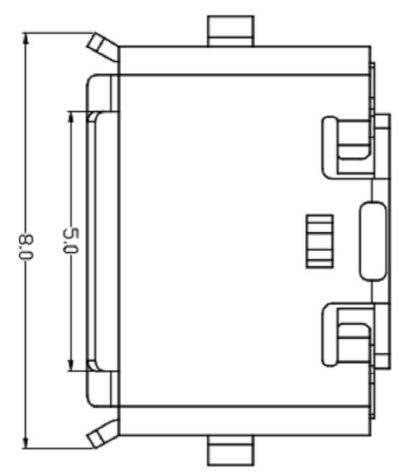
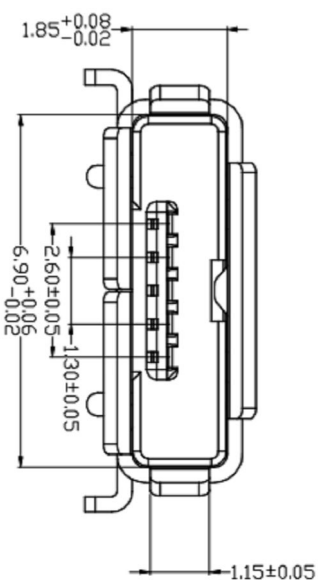


PCB LAYOUT




- Note:
1. Material:
 - 1.1 Housing: High temperature thermoplastic with 9.f,UL94v-0
 - 1.2 Contact: copper alloy,t=0.15mm
 - 1.3 Shell: copper alloy#SUS
 2. Specification:
 - 2.1 Current rating: 1 A Max.
 - 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - 2.3 Contact resistance: 30 mΩ Max.
 - 2.4 Insulation resistance: 100 MΩ Min.
 - 2.5 Total mating force: 3.57 Kgf Max.
 - 2.6 Total unmating force: 1.0 Kgf Min,0.81~2.05



REV	ECN NO	DESCRIPTION	DATE
A	JIONS-USB-0012		2015/03/17
1			

JIONS 北京玖思启明电子科技有限公司

X. ±0.30		APPD:	Mr.wu	TITLE:	
X. ±0.20		CHKD:	Mr.wu	MICRO USB AB型 方口 牛角	
.XX ±0.10				反向	
.XXX±0.05				PART NO: JIONS-0058	
X' ±2'		DR:	Gus chong	DWG NO: 客户图	
X' ±1'				WWW.jions.com.cn	
		UNITS:	mm	SCALE:	1:1
					SHEET: 0F1
				REV:	